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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Gerald Deboy

Serial No.: 10/790,979

Filed: March 2, 2004

Date Due: November 2, 2004

Title: SEMICONDUCTOR COMPONENT WITH INCREASED DIELECTRIC  
STRENGTH AND/OR REDUCED ON RESISTANCE



Examiner: Unassigned

Group Art Unit: 2811

Docket: I434.103.101/IFT975US

Mail Stop Amendments  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

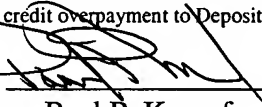
Sir:

We are transmitting herewith the attached:

- ☒ Transmittal Sheet containing Certificate of Mailing (1 pg.).
- ☒ Supplemental Information Disclosure Statement (2 pgs.).
- ☒ Form PTO-1449 (1 pg.).
- ☒ Copy of (2) cited reference.
- ☒ Return Postcard.

Please consider this a PETITION FOR EXTENSION OF TIME for a sufficient number of months to enter these papers, if appropriate. At any time during the pendency of this application, please charge any additional fees or credit overpayment to Deposit Account No. 500471.

**Customer No. 025281**

By:   
Name: Paul P. Kempf  
Reg. No.: 39,727

**CERTIFICATE UNDER 37 C.F.R. 1.8:** The undersigned hereby certifies that this paper or papers, as described herein, are being deposited in the United States Postal Service, as first class mail, in an envelope addressed to: Mail Stop Amendments, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 12<sup>th</sup> day of October, 2004.

By:   
Name: Paul P. Kempf

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Examiner: Unassigned

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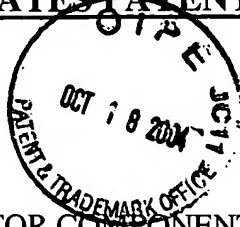
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**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Mail Stop Amendments  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In compliance with the duty of disclosure under 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached form 1449 be considered by the Examiner and made of record. Any required copies of patents, publications or other documents are enclosed for the Examiner's review. Pursuant to the provisions of M.P.E.P. 609, Applicant further requests a copy of the 1449 form, marked as being considered and initialled by the Examiner, be returned with the next Official Communication.

Since this Supplemental Information Disclosure Statement is being submitted within three months of filing national application; or date of entry of national application; or before the mailing date of the first Office Action on the merits, a fee has not been enclosed. However, if such fee is required, the Patent Office is hereby authorized to charge Deposit Account No. 500471 for fees as set forth under 37 C.F.R. 1.17(p).

**Supplemental Information Disclosure Statement**

Applicant: Gerald Deboy

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Applicant respectfully requests consideration of these references during prosecution of the above-identified matter. The Examiner is invited to contact the Applicant's representative at the below-listed telephone number if there are any questions regarding this Communication or the tendered references.

Respectfully submitted,

Gerald Deboy,

By his attorneys,

DICKE, BILLIG & CZAJA, PLLC

Fifth Street Towers, Suite 2250

100 South Fifth Street

Minneapolis, MN 55402

Telephone: (612) 767-2502

Facsimile: (612) 573-2005

Dated: 10/12/04

PPK:cmj

  
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Paul P. Kempf

Reg. No. 39,727

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By   
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Name: Paul P. Kempf

